WORKMAN NYDEGGER
A PROFESSIONAL CORPORATION
A PATTORNEYS AT LAW
1000 EAGLI F GATE TOWER

ABSTRACT OF THE DISCLOSURE

Methods of manufacturing lead frame connectors for use in connecting optical sub-

assemblies to printed circuit boards in optical transceiver modules. The lead frame

connectors are formed by first stamping a selected configuration of conductors in a

conductive ribbon. The conductors are bent as necessary and passed in a reel-to-reel manner

through an insert injection molding process to form an electrically insulating casing about the

conductors. After the molding process, the ribbon is singulated to obtain individual lead

frame connectors. The individual conductors encased in the casing can be electrically

separated by punching out a connecting conductive structure through a hole formed in the

casing. The connecting conductive structure mechanically secures the conductors to each

other during the molding process and, when punched out, substantially eliminate stubs that

could otherwise degrade the RF performance of the lead frame connectors.

W:\15436\447\BLM0000002264V001.doc

ALLOWAGETS AT LAW
1000 EAGLE GATE TOWER
60 EAST SOUTH TEMPLE
ALT LAKE CITY, UTAH 84111

- Page 17 -

Docket No. 15436.447.1